



Call for Papers

2007 IEEE Conference on Electron Devices and Solid-State Circuits

December 20-22, 2007, Taiwan

<http://www2.eecs.stut.edu.tw/~edssc2007>

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IEEE International Conference on Electron Devices and Solid-State Circuits 2007 (EDSSC2007) will be held in Tainan, Taiwan from December 20, 2007 (Thursday) to December 22, 2007 (Saturday). We invite research scientists and engineers around the world to submit their recent results and to participate in the conference. The Conference is co-sponsored by IEEE Electron Devices Society, IEEE Solid-State Circuits Society, and Southern Taiwan University. The three-day program comprises broad areas in electron devices, materials and solid-state circuits. Topics of interest include, but not limited to:

Nanoelectronics
Memory Device and Technology
Thin Gate Dielectrics
Photonic Devices
RF & Microwave Devices
Power Devices
Sensors and MEMS

Low-Power Circuits
GHz Digital Circuits
Analog Circuit Techniques
Photonic Integrated Circuits
RF & Microwave Circuits
Power Circuits
IC Manufacturing and Packaging

Authors are requested to submit full papers in camera-ready form to the Technical Program Chair via the "Submit Paper" column of the website. Detail of submission will be given in the conference website in the beginning of 2007. All submissions must be in English and the works must be original and unpublished. The paper must be on A4 size paper (single-sided with 20 mm margin on all sides). Invited paper should not be more than six pages and regular paper should be in four-page long. Details of the paper format can be downloaded from the Conference website in early 2007.

Important Dates:

Submission Deadline: August 24, 2007
Notice of Acceptance : October 30, 2007
Early registration by: November 1, 2007

Student Paper Contest

Student paper contest will be held as part of the Conference. Three prizes, i.e. first, second and third prizes, will be awarded. Papers presented by full-time students and based on their own work will be considered for the competition. Qualified papers should be indicated at the time of submission.

Inquiry:

Please Contact: Professor T. K. Chiang,
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Information for Potential Authors

Paper Submission Deadline: August 24, 2007

Paper Format:

The paper should contain up to 4 pages, with a **Journal Publication** format with the following specifications:

- Paper size: Single sided-A4 (210 x 297mm or 8.27" x 11.69")
- Margin: 20mm on all sides
- Font size: 10 points or above
- No page numbers should be included

On the first page of the paper, it should contain:

- Title of the paper (with 22 points Time New Roman font)
- Name of Author(s) (with 14 points Time New Roman font)
- Author affiliation(s) and contact(s) (in the lower left corner with 9 point Time New Roman font)

A sample paper can be found from the conference website of

<http://www2.eecs.stut.edu.tw/~edssc2007/>

Papers should be submitted via the website given below:

<http://www2.eecs.stut.edu.tw/~edssc2007/>

Electronic submission is the preferred means of paper submission. But if paper submission by mail is really desired, it can be submitted by post to the addresses given below:

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